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Improved properties of Al–Si₃N₄ nanocomposites fabricated through a microwave sintering and hot extrusion process

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In this study, nano-sized Si_3N_4 (0, 0.5, 1.0 and 1.5 vol%)/Al composites were fabricated using a powder metallurgy method involving microwave sintering technique followed by hot extrusion. The influence of Si_3N_4 content on the structural, mechanical and thermal behaviour of Al–Si_3N_4 nanocomposites was systematically investigated. Electron microscopy examination reveals the uniform distribution of hard Si_3N_4 nanoparticles in the soft Al matrix. The compressive and tensile strengths of Al composites increased with the increase of Si_3N_4 content while the ductility decreased. The thermal expansion coefficient of the Al composite decreased with the progressive addition of hard Si_3N_4 nanoparticles. Overall, hot extruded Al–1.5 vol% Si_3N_4 nanocomposites exhibited the best combination of tensile, compressive, hardness, Young's modulus and thermal properties of 191 ± 4 MPa, 412 ± 3 MPa, 16.3 ± 0.8 GPa, 94 ± 2 GPa and 19.3 μ K⁻¹, respectively. Tensile tests performed at 200 °C revealed that the tensile strength reduced by ∼35% when compared to the strength at room temperature. The strength, however, was still higher compared to that of the pure Al at 200 °C. The major enhancement in the strength of the nanocomposites is primarily attributed to the presence of uniformly distributed nano-sized Si_3N_4 nanoparticles in the Al matrix.

1. Introduction

Aluminum metal matrix composites (AMMCs) are potential candidates for a wide spectrum of applications in the automobile and aerospace structure industries, due to their high specific modulus, strength and thermal stability.[1,2] Light weight metal matrix composites (Al, Mg and Ti based) consist of a metallic matrix and ceramic particles as reinforcement. Commonly used reinforcing ceramics belong to oxide, carbide, boride and nitride families. Generally, micron length scale powder particles are used as reinforcing phase in the metal matrix.

Recently, there is a considerable interest in the production of metal matrix nanocomposites in which nanoparticulates are incorporated into the base matrix. The production of nanocomposites is currently in the exploration and experimental research stage. When compared to composites with micronsized reinforcements, nanocomposites exhibit comparable or better mechanical properties with the use of a lower amount of nanoparticulate reinforcements.[3–7]

The most commonly used particulate reinforcements are silicon carbide and alumina[8,9] but AlN, Si_3N_4, TiC, B_4C, MgO, and graphite are also being used.[10–14] Especially, silicon nitride (Si_3N_4) exhibit high chemical and thermal stability, higher hardness, strength and excellent corrosion, wear and creep resistance.[15] A uniform distribution of reinforcement in a fine grained metal matrix is critical for the enhancement of the mechanical characteristics of AMMCs.

The end properties of composites are also significantly affected by the type, size and amount of reinforcement.[16–18] However, to synthesize MMCs, the choice of reinforcing particles depends on the cost of the materials used, final application, and the manufacturing method adopted.[19] Composites containing ceramic particles have been successfully fabricated by casting method[20] and powder metallurgy (PM) methods such as cryomilling,[21] ball milling[22] and wet mixing process.[23] PM methods usually involve blending of powders, compaction and solid state sintering followed by secondary deformation process such as extrusion. Among these steps, sintering is an important step because it have the ability to develop the microstructural characteristics that govern the final properties of the material. Sintering can be done in many ways involving plasma, radiant, induction and microwave heating techniques.[24] Among various sintering techniques, microwave sintering include rapid and more uniform heating, prevention of hot spot formation, more uniform and finer microstructure leading to high performance products.[25,26]

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Accordingly, the aim of the present research work was to fabricate high performance aluminum metal matrix composites for structural applications. It focuses on new Al composites containing Si_3N_4 nanoparticles developed by a combination of blending, rapid microwave sintering and hot extrusion techniques. The effect of the Si_3N_4 content on the microstructural, mechanical and thermal characteristics of the Al–Si_3N_4 nanocomposites was investigated in detail.

2. Experimental

Pure Al powder (99% purity, Alfa Aesar, USA) with an average size of ~7–15 μm was used as the matrix and silicon nitride (Si_3N_4, 99% purity, Alfa Aesar, USA) with an average size of ~15–30 nm was used as the reinforcement for the synthesis of Al–Si_3N_4 nanocomposites.

The pure powders were carefully mixed with the required amount of silicon nitride (0, 0.5, 1.0 and 1.5 vol%). The mixing process was performed at room temperature using a Retsch PM400 planetary ball mill for 2 h at the milling speed set at 200 rpm in order to get a homogeneous particle distribution. No balls were used in this stage. The blended powder mixtures were compacted at a pressure of 97 bar (50 tons) into green compacts of size 35 mm diameter and 40 mm length. The compacted cylindrical billets were sintered at 550 °C using an novel hybrid microwave assisted two-directional sintering technique.[27]

The microwave sintered billets were subjected to hot extrusion at 350 °C and under load of 500 MPa, with an extrusion ratio of 20.25 : 1 to produce extruded rods of 8 mm diameter. These extruded rods were subsequently used for characterization and testing as per ASTM standards. The schematic diagram of the experimental process is shown in Fig. 1.

The phase analysis was performed using X-ray diffractometer (PANalytical X'pert Pro) with Cu K_α radiation. The operating parameters were 40 kV and 40 mA, with a 2θ step size of 0.02°. The microstructure observation and element analysis of the polished surfaces of diametric cross-sections were carried out using a scanning electron microscope (JEOL JSM-6010 and Hitachi FESEM-S4300) equipped with energy dispersion spectroscopy (EDS) detector.

Microhardness was determined using a Vickers tester (FM-ARS9000, USA) under an applied load of 100 gf with an indentation time of 15 s as per the ASTM standard E384-08.

Nanoindentation measurements at room temperature were performed using a MFP-3D Nano Indenter (head connected to AFM equipment) system equipped with standard Berkovich diamond indenter tip. The forces applied were in the mN range, and penetration depths ranged from several nm to μm. The microhardness and young's modulus (E) from nanoindentation test were calculated directly. The indentation was made at a maximum load of about 100 mN and under loading and unloading rate of 200 μN s^{-1} and dwell time at maximum load was kept at 5 s. With the aim of take the repeatability into account, the test results were calculated from the average of 6 indentations.

Compressive testing of the cylindrical specimens was done at room temperature according to the procedures given in the ASTM standard E9-89a using Universal testing machine-Lloyd. The test specimens with a length to diameter (l/d) ratio of ~1 were subjected to a compression load at a constant strain rate of 8.3×10^{-4} s^{-1}. From the load–displacement curves, 0.2% offset yield strength (YS), ultimate compression strength (UCS) and failure strain were determined.

Tensile testing was carried out as per the ASTM E8/E8M-15a using universal testing machine at room temperature (RT), 100 °C and 200 °C using a strain rate of 8.3×10^{-4} s^{-1}. For each composition, three samples were tested to ensure repeatable values. From the load displacement curves, 0.2% offset yield strength (YS), ultimate tensile strength (UTS) and percentage elongation (ductility) were determined.

The fracture surfaces of the compression and tensile specimens were examined by field emission scanning electron microscope (Hitachi FESEM-S4300).

Coefficient of thermal expansion (CTE) of Al–Si_3N_4 nanocomposites was determined using a INSEIS TMA PT 1000LT thermo-mechanical analyzer at a heating rate of 5 °C min^{-1} for a temperature range of 50–350 °C with an argon flow rate of 0.1 lpm.

3. Results and discussion

XRD analysis of Al–Si_3N_4 nanocomposites

The X-ray diffraction (XRD) patterns of the microwave sintered Al–Si_3N_4 nanocomposites with different volume fraction of the reinforcement shown in Fig. 2 confirms the presence of Si_3N_4 particulates within the aluminium matrix. The peak of Si_3N_4 was weak due to low amount of Si_3N_4 (<2 vol%) but visible in the case of Al–1.5 vol% Si_3N_4. These peaks are recognized with the help of JCPDS software. The XRD results also approve the elemental map results which verifies that the fabricated nanocomposites are Si_3N_4 reinforced Al composites.
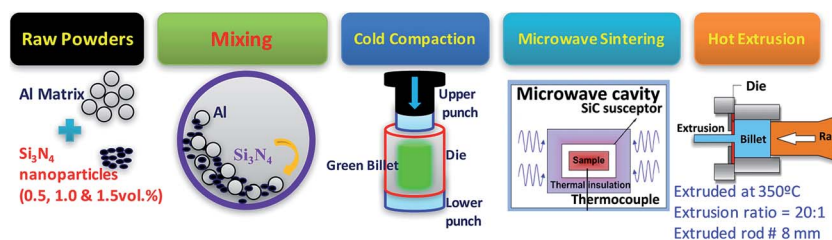

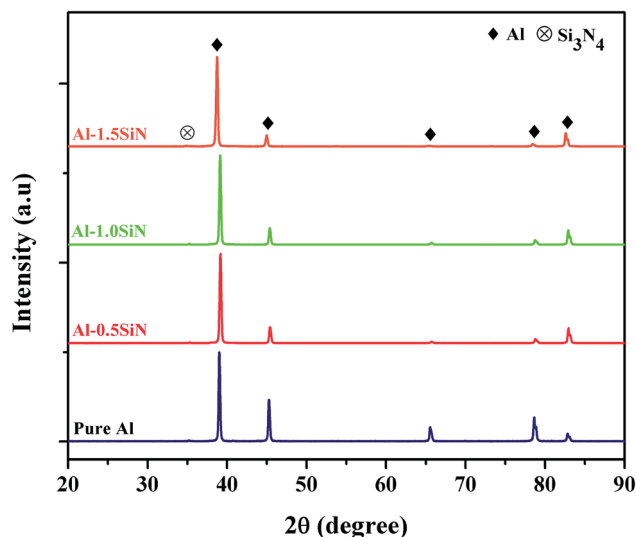Fig. 1 Schematic representation of the fabrication of Al–Si_3N_4 nanocomposites.

Fig. 2 XRD patterns of extruded Al–Si$_3$N$_4$ nanocomposites.

Microstructural analysis of Al–Si$_3$N$_4$ nanocomposites

The microstructure of the Al–Si$_3$N$_4$ nanocomposites was studied by using a field-emission scanning electron microscope (FESEM) and the corresponding micrographs are shown in Fig. 3. The SEM images of hot extruded composites reveal the homogeneous distribution of Si$_3$N$_4$ nanoparticles (white areas) in the Al metal matrix (grey areas). At some places cluster of Si$_3$N$_4$ particulates were also observed and may be attributed to different density of Si$_3$N$_4$ particles (3.44 g cm^{-3}) when compared to that of aluminium (2.7 g cm^{-3}).

Fig. 4 shows the SEM image of the Al–1.5 vol% Si$_3$N$_4$ nanocomposites along with corresponding EDS elemental mapping images of Al, Si & N and EDX spectrum. The elemental distribution map clearly reveals the homogeneous distribution of Si$_3$N$_4$ nanoparticles in Al matrix. The Si and N elemental mapping images are in good agreement with the distribution of Si$_3$N$_4$ in Al matrix.

Microhardness of Al–Si$_3$N$_4$ nanocomposites

Hardness is a useful mechanical property that provides valuable insight into overall mechanical behaviour of composites. Generally, several factors would affect the microhardness of the composites such as particle shape, size, amount, distribution,

density of reinforcement and method of preparation.[28] Fig. 5 shows the hardness of the pure Al and Al–Si$_3$N$_4$ nanocomposites. It can be observed that the hardness increased with increasing the content of nano-sized Si$_3$N$_4$ particles. The hardness of the unreinforced pure Al was found to be 37 ± 3 HV, while that of Al–1.5 vol% Si$_3$N$_4$ nanocomposites were around 101 ± 5 HV (1.7 times). This increase in the hardness is because of the presence of hard ∼15 nm Si$_3$N$_4$ in the matrix. Similar outcomes of rise in hardness with increasing amount of reinforcement in the matrix irrespective of the fabrication process of AMMCs were reported by researchers earlier.[29,30] Also, the microhardness values of the microwave-extruded samples in this study were found to be higher than those of the conventional or stir cast samples.[29,30]

The presence of hard ceramic particles can enhance the microhardness of composites according to the rule of mixtures.[31]

$$H_c = H_m f_m + H_r f_r \qquad (1)$$

where, H_c represents hardness of the composite, H_m and H_r represents hardness of the matrix and the reinforcing particle, respectively, and f_m and f_r represents the volume fraction of the matrix and the reinforcing particle, respectively.

Nanoindentation studies of Al–Si$_3$N$_4$ nanocomposites

The load–displacement plots from nanoindentation for the extruded pure Al and Al–Si$_3$N$_4$ nanocomposite samples are presented in Fig. 6(a). A maximum load of 100 mN was applied, and the indentation depth resides within 1.3 to 2.4 nm. Lower depth of penetration in composites can be observed from the nanoindentation graphs in comparison to that of pure Al. The decrease of indentation depth with the increase in hardness agrees with the fact that hardness increased with increase in volume fraction of Si$_3$N$_4$ particles. A similar trend in the hardness values was observed in the AA6082-Si$_3$N$_4$ composites.[29] The lower displacement is attributed to the higher resistance offered by the matrix incorporated with hard Si$_3$N$_4$ particles to the indenter.

The Young's modulus and hardness of extruded pure Al and Al–Si$_3$N$_4$ nanocomposite samples achieved directly from the nanoindentation test, are shown in Fig. 6(b). The Young's modulus and hardness increased with increasing amount of hard Si$_3$N$_4$ nanoparticles. The enhanced modulus for the
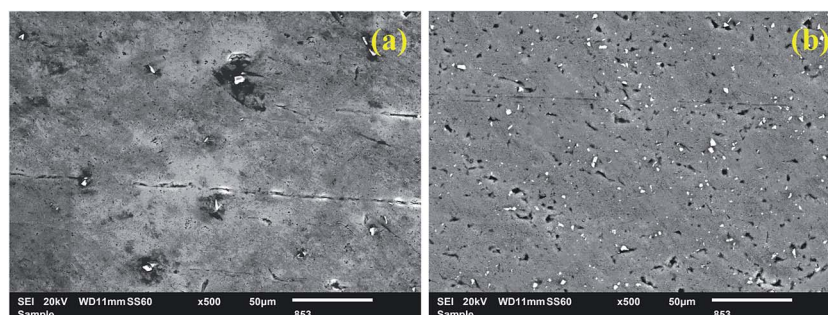

Fig. 3 SEM micrographs of extruded (a) Al–0.5 vol% Si$_3$N$_4$ and (b) Al–1.5 vol% Si$_3$N$_4$ nanocomposites.
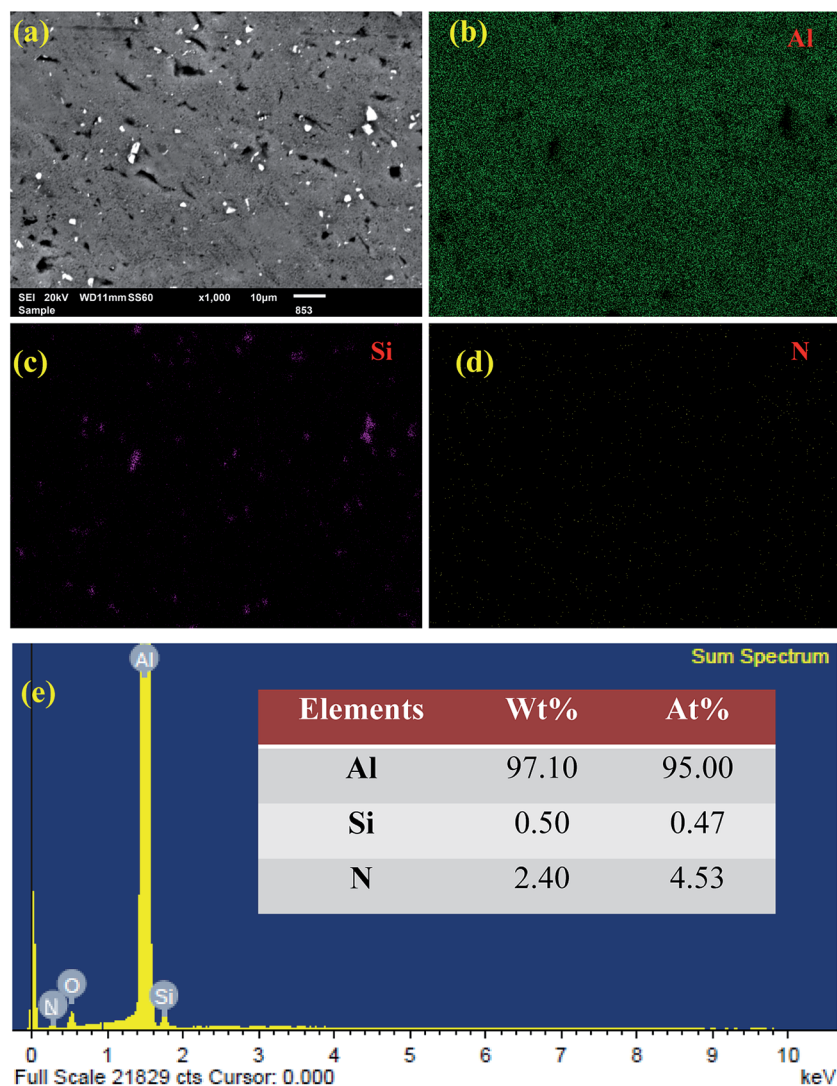
Fig. 4 (a) SEM images of extruded Al–1.5 vol% Si_3N_4 nanocomposites and corresponding EDS mapping images of (b) Al, (c) Si, (d) N elements and (e) EDX spectrum.

extruded composites from 73 ± 5 to 88 ± 2 GPa by increasing Si_3N_4 from 0 to 1.5 vol% is attributed to the high modulus of Si_3N_4 nanoparticles in the aluminium matrix.

Compressive analysis of Al–Si_3N_4 nanocomposites

Fig. 7 shows the representative engineering stress–strain curve obtained under compressive loading conditions. It can be observed that the shape of the stress–strain curves display a downward concave profile after yield. The results of compressive testing revealed an improvement in 0.2% YS and UCS for all the composite formulations investigated when compared to pure aluminum, as seen in Table 1. With the addition of Si_3N_4 nanoparticles, the yield strength and ultimate compression strength (UCS) of Al–1.5 vol% Si_3N_4 nanocomposites are 142 ± 6 MPa and 412 ± 3 MPa, which are increased by 32% and 103%, respectively, compared to those of the pure Al (70 ± 3 MPa and 313 ± 5 MPa). The increase in UCS is because of the presence of Si_3N_4 particles and the

strengthening mechanism was triggered due to their presence. It can be observed that the ultimate compressive strength of the microwave-hot extruded Al–Si_3N_4 nanocomposites is superior to that of conventional sintered AMMCs.[29,30]

Tensile analysis of Al–Si_3N_4 nanocomposites

Tensile stress strain curves of monolithic and nanocomposites conducted at ambient temperature under uniaxial tensile loading are shown in Fig. 8(a). The corresponding tensile test data variation as a function of amount of Si_3N_4 is shown in Fig. 8(b).

The results of the tensile testing show that the use of silicon nitride nano reinforcing particles in pure Al led to a considerable increase in 0.2% yield strength and ultimate tensile strength (UTS) of pure Al suggesting that the Si_3N_4 particles can strongly improve the strength of the soft Al matrix. The 1.5 vol% nano-sized Si_3N_4/Al composite exhibited the best tensile properties. The yield strength, UTS and elongation of the 1.5 vol%
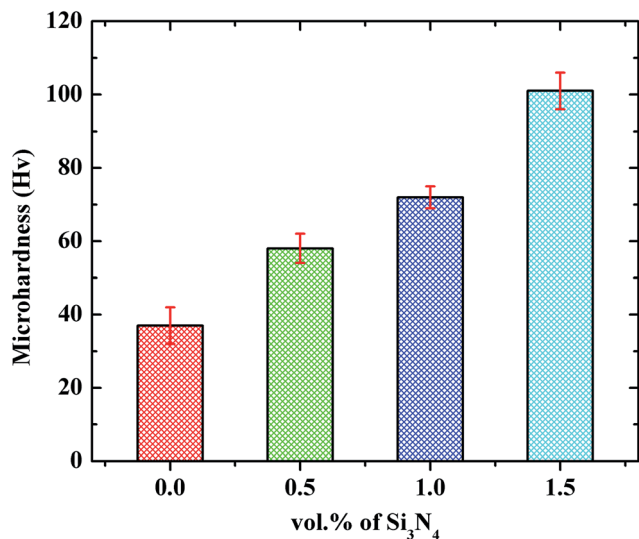
Fig. 5 Hardness of extruded Al–Si$_3$N$_4$ nanocomposites with various Si$_3$N$_4$ content.

nano-sized Si$_3$N$_4$/Al composite are 165 ± 5 MPa, 191 ± 4 and 8.2%, which changed by +24%, +65% and −40% respectively, compared to those of the pure Al (105 ± 2 MPa, 116 ± 4 MPa and 13.6%). It can be noted that the ultimate tensile strength of the

microwave-hot extruded Al–Si$_3$N$_4$ nanocomposites are clearly superior to that of conventional sintered AMMCs.[29,30,32]

The results presented in Table 1 show that the tensile strength of microwave-extruded Al–Si$_3$N$_4$ nanocomposites are considerably higher than those of stir cast + extruded Al–Si$_3$N$_4$ matrix composites reported so far.[29] These results can be attributed to the fairly uniform distribution of reinforcement particles and good matrix-reinforcement interfacial integrity.

In order to meet the requirement for heat resistance materials, the mechanical properties of the Al–Si$_3$N$_4$ (0 to 1.5 vol%) nanocomposites at high temperatures (100 °C and 200 °C) were also investigated, as shown in Fig. 9(a) and (b).

It was already expected that the material will soften when tested at higher temperatures. For the Al–1.5 vol% Si$_3$N$_4$ nanocomposite, the ultimate tensile strength and yield strength decreased when the tensile tests were carried out at 100 and 200 °C. The softening of the matrix together with the grain growth along with increasing test temperature leads to less pronounced strain hardening behaviour in these composites.[33] It was found that the UTS of the samples were markedly prominent for extruded Al–Si$_3$N$_4$ nanocomposites. At 200 °C, the UTS of Al–1.5 vol% Si$_3$N$_4$ nanocomposite is ∼124 ± 4 MPa. With increasing heating temperature, UTS of all samples decreases. The developed microwave-extruded Al–1.5 vol% Si$_3$N$_4$ nanocomposite possesses incredible properties especially at high temperatures. Based on the experimental data the
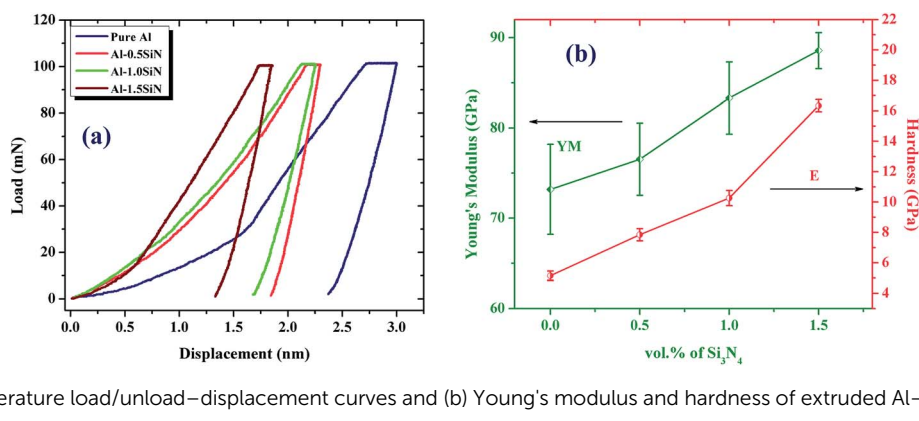

Fig. 6 (a) Room temperature load/unload–displacement curves and (b) Young's modulus and hardness of extruded Al–Si$_3$N$_4$ nanocomposites.
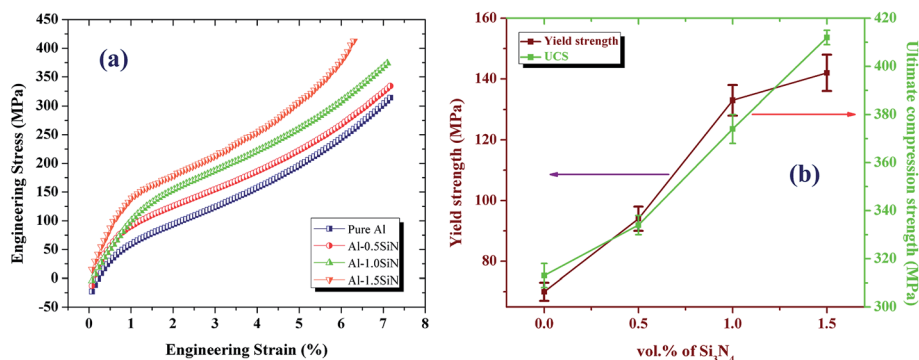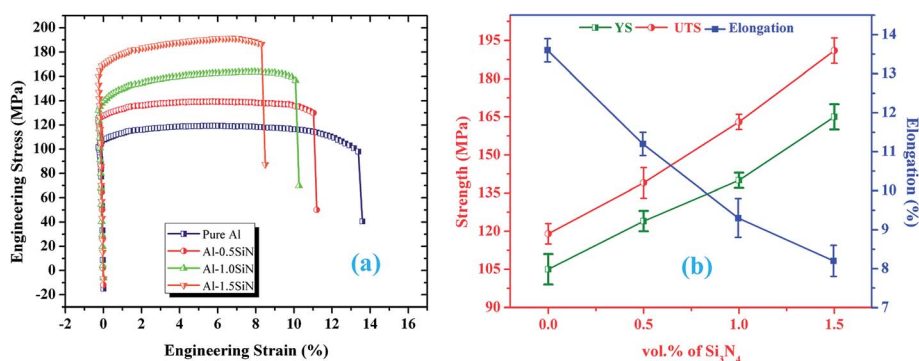

Fig. 7 Representative compressive stress–strain curves (a) and variation in YS and UCS with amount of Si$_3$N$_4$ (b) of extruded Al–Si$_3$N$_4$ nanocomposites.

Table 1 Mechanical properties of pure Al and Al–Si₃N₄ nanocomposites

	Hardness		Young's modulus (GPa)	Compressive properties			Tensile properties		
Sample	(HV)	(GPa)		CYS (MPa)	UCS (MPa)	Failure strain (%)	TYS (MPa)	UTS (MPa)	Elongation (%)
Pure Al	37 ± 3	5.1 ± 0.3	73 ± 5	70 ± 3	313 ± 5	>70	105 ± 2	116 ± 4	13.6 ± 0.3
Al–0.5 vol% Si₃N₄	58 ± 4	7.8 ± 0.4	77 ± 4	94 ± 4	336 ± 4	>70	124 ± 4	139 ± 7	11.2 ± 0.3
Al–1.0 vol% Si₃N₄	72 ± 3	10.2 ± 0.5	83 ± 4	133 ± 5	374 ± 6	>70	140 ± 5	163 ± 5	9.3 ± 0.5
Al–1.5 vol% Si₃N₄	101 ± 5	16.3 ± 0.8	88 ± 2	142 ± 6	412 ± 3	>70	165 ± 8	191 ± 6	7.2 ± 0.4

Fig. 8 Representative tensile stress–strain curves (a) and variation in YS, UTS and Elongation with amount of Si₃N₄ (b) of extruded Al–Si₃N₄ nanocomposites.

authors achieved, there are mainly two reasons for the remarkable performance of the Al–Si₃N₄ nanocomposite at high temperatures: one is the high thermal stability of Si₃N₄ and the other one is related to the reasonably uniform spatial distribution of Si₃N₄ particles throughout the Al matrix.

## Strengthening mechanism analysis

Several mechanisms and theories have been recommended to elucidate the strengthening of metal matrix composites. To understand the strengthening effects of ceramic reinforcement nanoparticles on the hardness, compression and tensile properties of composites such as UTS and YS, it is prudent to discuss the strengthening mechanism in details. In the present study strengthening occurs due to the following mechanism (i) active load transfer from the matrix to the reinforcement, (ii) Orowan strengthening, (iii) generation of internal thermal stresses because of the difference in the co-efficient of thermal expansion (CTE) between the reinforcement particles and matrix phase and (iv) effect of nano-sized reinforcement.

The efficient load transfer (σ_{load}) between the ductile matrix and the hard-ceramic reinforcement particles occurs during tensile testing. Mainly when the interfacial contact between the matrix and the reinforcement is good enough and it is represented as follows:[34–36]

$$\sigma_{load} = 0.5 V_f \sigma_{YM} \qquad (2)$$

where, V_f is the volume fraction of ceramic reinforcement particles and σ_{YM} is the matrix yield stress.
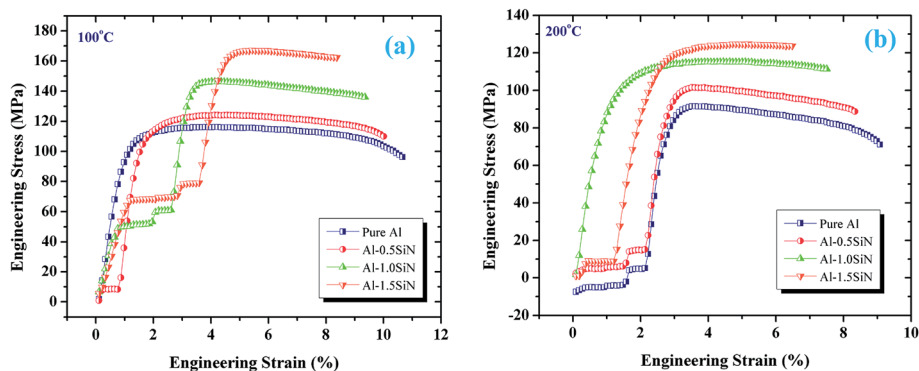
Fig. 9 Representative tensile stress–strain curves of extruded Al–Si₃N₄ nanocomposites at different temperatures.
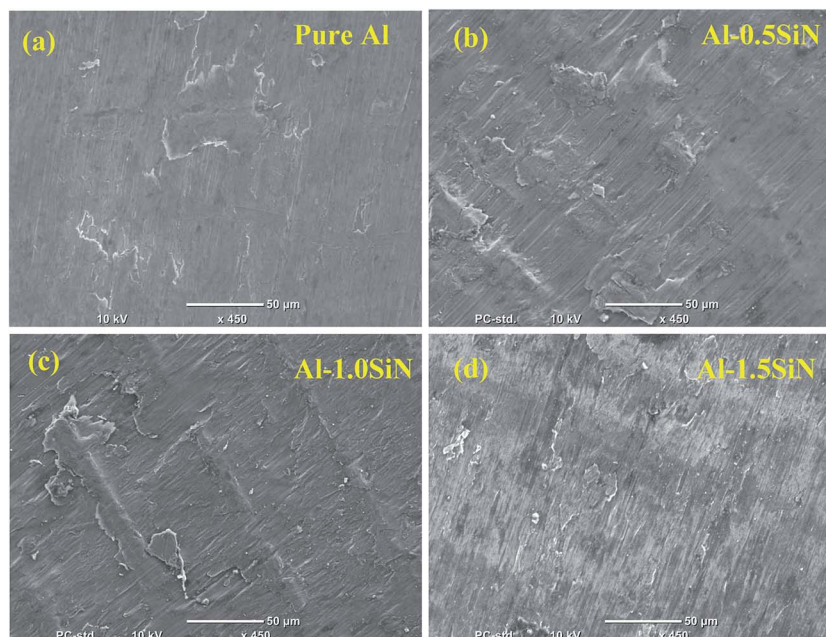
Fig. 10 Compression fracture surfaces of extruded Al–Si$_3$N$_4$ nanocomposites after testing at RT.

The interaction between the dislocations and the reinforcement particles enhances the strength of the composite materials in agreement with the Orowan mechanism. Due to the existence of dispersed reinforcement particles in the matrix, dislocation loops are formed when dislocations interact with the reinforcing particles. σ_{Orowan} can be calculated as:[37]

$$\sigma_{\text{Orowan}} = \frac{0.13Gb}{\lambda} \ln \frac{r}{b} \qquad (3)$$

where, G is the shear modulus of matrix, b is the Burgers vector, r is the particle radius and λ is the inter-particle spacing.

The variation in the CTE values of the metal matrix and the reinforcement particles produces thermally induced residual stresses and geometrically essential dislocations. The thermal stresses at the particles and matrix interface enhance the hardness and flow stresses in the material, making the plastic deformation more difficult. The mismatch strain effect due to the difference between the CTE values of particles and that of the matrix is given by:[38]
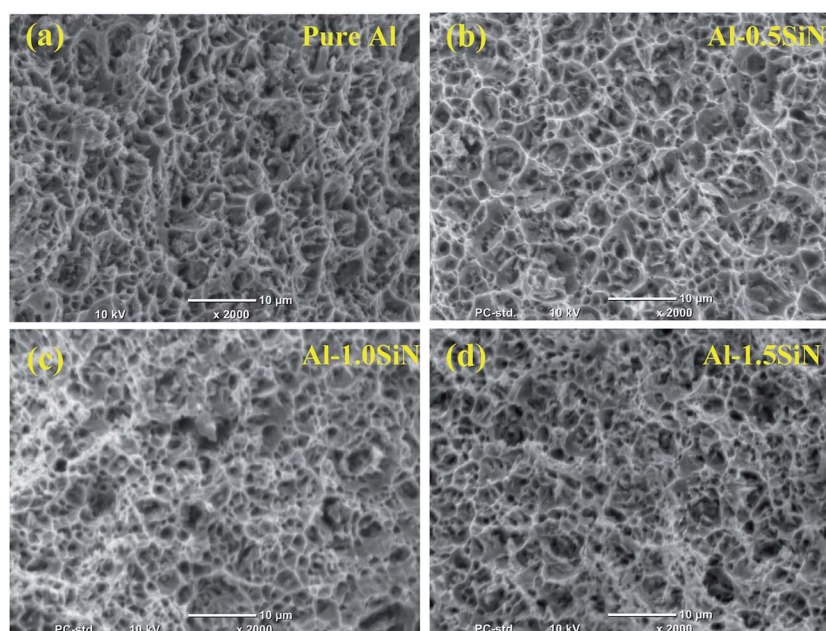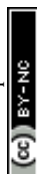

Fig. 11 Tensile fracture surfaces of extruded Al–Si$_3$N$_4$ nanocomposites after testing at RT.
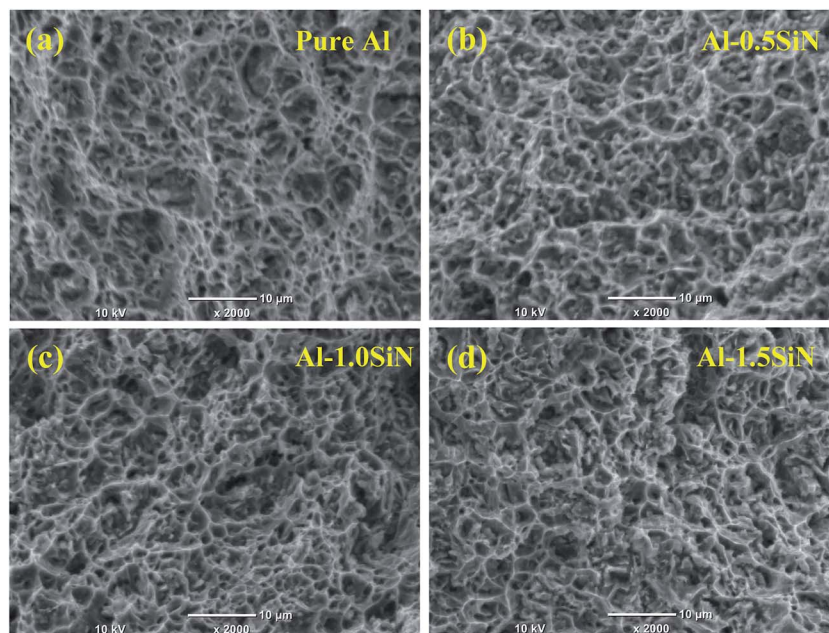
Fig. 12 Tensile fracture surfaces of extruded Al–Si$_3$N$_4$ nanocomposites after testing at 200 °C.

$$\Delta\sigma_{\text{CTE}} = \sqrt{3}\beta G_m b \sqrt{\frac{24 V_f \Delta\alpha \Delta T}{(1-V_f)b r_p}} \qquad (4)$$

where, b is the strengthening coefficient, $\Delta\alpha$ is the difference between CTE of matrix and reinforcement and ΔT is the difference between the test and process temperature. In Al–Si$_3$N$_4$ nanocomposites, there is a large difference in the thermal expansion coefficient (CTE) between matrix (24×10^{-6} per K for Al) and reinforcement (3.7×10^{-6} per K for Si$_3$N$_4$).

When compared to the micron-sized ceramic reinforcements, the nano-sized ceramic reinforcements exhibit superior tensile strength and excellent ductility and that too in low volume fractions.[39,40] Large reinforcement particles are commonly associated with cleavage and interfacial deboning resulting into the formation of pits or cavities.

Failure analysis

The fracture surfaces of compression and tensile tested samples were studied using SEM, in order to understand the type of fracture under different types of loading and at different temperatures.

Fig. 10(a–d) is showing the fractured surfaces of pure Al and Al–Si$_3$N$_4$ composites under compressive loading. A typical shear mode fracture can be observed in these nanocomposites under compressive loading and the fractured samples show a crack at 45° to the test axis. It approves that the compressive deformation of the Al-composites is expressively indifferent. This is due to assorted deformation and work hardening behaviour.[41] The plastic deformation in the composites was restricted due to the dispersion of second phases in the matrix.

The fracture observed in the composites depends on a variety of factors including the processing method, heat treatments cycles, the applied stresses, distribution and morphology of the reinforcing particles. Fractographs taken from the tensile fracture surfaces (at RT and 200 °C) of pure Al and Al–Si$_3$N$_4$ nanocomposite samples are shown in Fig. 11 and 12, respectively. The images show the features of a typical ductile fracture in pure Al and the Al–Si$_3$N$_4$ composites samples.

Coefficient of thermal expansion of Al–Si$_3$N$_4$ nanocomposites

The CTE values of the synthesized pure Al and Al–Si$_3$N$_4$ nanocomposites are shown in Fig. 13. The CTE values for Al–0.5 vol% Si$_3$N$_4$ (21.8 μ K^{-1}), Al–1.0 vol% Si$_3$N$_4$ (20.23 μ K^{-1}) and Al–1.5 vol% Si$_3$N$_4$ (19.3 μ K^{-1}) were found to be ∼6.5%, ∼13.2 and ∼17.2% lower than that of pure Al (23.31 μ K^{-1}).
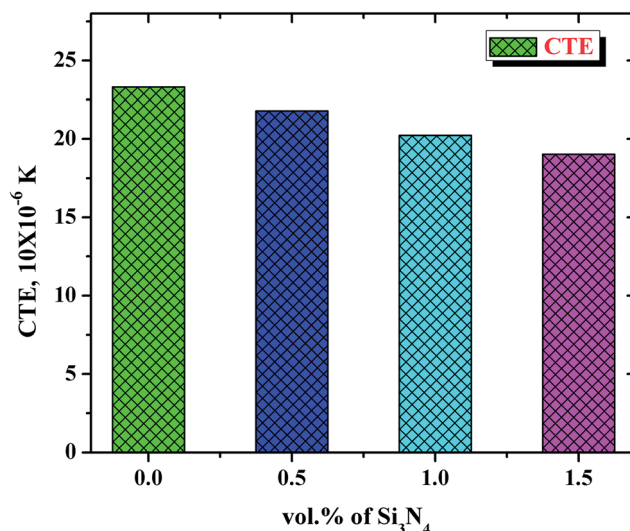

Fig. 13 The variation of CTE of extruded Al–Si$_3$N$_4$ nanocomposites.

As observed, the CTE value of pure aluminum follows a linear decreasing trend with the progressive addition of Si_3N_4 particles which is found to be in accordance with the theory that the thermal expansion of composites is governed by the competing interactions of expansion of Al matrix and the constraint of reinforcement particles through their interfaces.[29] This decrease in the CTE values can be ascribed to the lower CTE value of silicon nitride $(1.4–3.7\ \mu\ K^{-1})$[41] when compared to that of pure Al $(24\ \mu\ K^{-1})$.[42] Good interfacial integrity between the aluminium matrix and Si_3N_4 nanoparticulates and limited agglomeration of Si_3N_4 nanoparticulates in the developed nanocomposites. The results of CTE measurements suggest that the Si_3N_4 nanoparticulates contribute positively to the dimensional stability of pure Al.

4. Conclusions

Nano-sized Si_3N_4 particulate reinforced Al composites have been successfully synthesized by microwave sintering followed by hot extrusion. Microstructure of composites shows fairly uniform distribution of nanoparticles in the Al matrix. The Si_3N_4 addition leads to a linear increase in Young's modulus and hardness values of Al-matrix. Al–1.5 vol% Si_3N_4 composite exhibits the best compressive properties as the yield strength and UCS increases upto 142 ± 6 MPa and 412 ± 3 MPa, respectively. The yield strength and UTS under tensile loading also shows a major increment upto 165 ± 8 MPa and 191 ± 6 MPa, respectively where as the ductility showed a decreasing trend. The shear band and dimple formations were observed in Al–1.5 vol% Si_3N_4 nanocomposites under compression and tensile loading, respectively. Coefficient of thermal expansion values decreased with the increasing content of Si_3N_4 particles, indicating high dimensional stability of nanocomposites.

Acknowledgements

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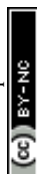
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